



LTC1385

3.3V Low Power EIA/TIA-562 Transceiver

FEATURES

- Operates from a Single 3.3V Supply
- Low Supply Current: $I_{CC} = 200\mu A$
- $I_{CC} = 35\mu A$ in Driver Disable Mode
- $I_{CC} = 0.2\mu A$ in Shutdown Mode
- ESD Protection Over $\pm 10kV$
- Uses Small Capacitors: $0.1\mu F$
- Operates to 120kBaud
- Output Overvoltage Does Not Force Current Back into Supplies
- EIA/TIA-562 I/O Lines Can Be Forced to $\pm 25V$ Without Damage
- Pin Compatible with LT1180A

APPLICATIONS

- Notebook Computers
- Palmtop Computers

DESCRIPTION

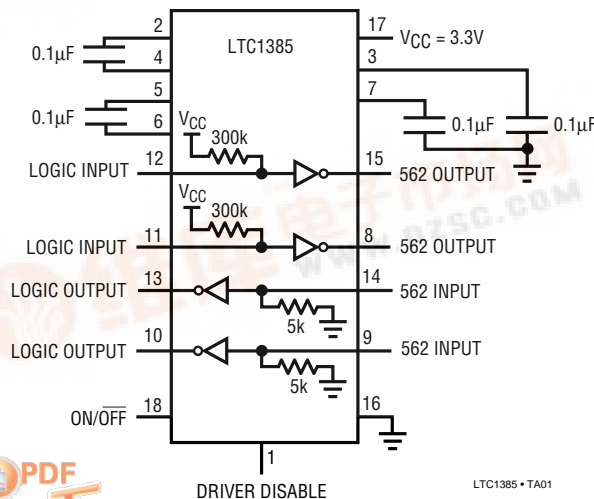
The LTC1385 is an ultra-low power, 2-driver/2-receiver EIA/TIA-562 transceiver which operates from a single 3.3V supply. The charge pump requires only four space-saving $0.1\mu F$ capacitors.

The transceiver operates in one of three modes: Normal, Driver Disable or Shutdown. In the Normal mode, I_{CC} is only $200\mu A$ in the unloaded condition. In the Driver Disable mode, the charge pump is turned off, the driver outputs are forced into three-state, both receivers are kept active, and I_{CC} drops to $35\mu A$. In the Shutdown mode, everything is turned off and I_{CC} drops to $0.2\mu A$.

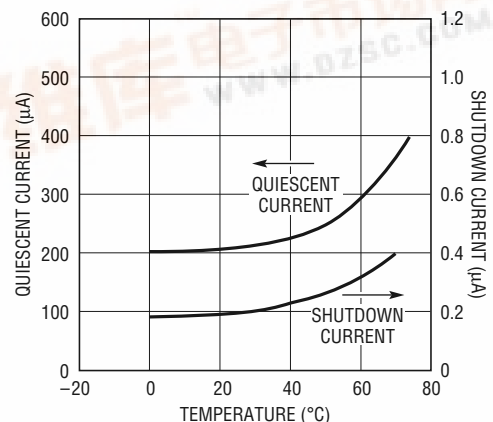
The LTC1385 is fully compliant with all data rate and overvoltage EIA/TIA-562 specifications. The transceiver can operate up to 120kbaud with a $1000pF$, $3k\Omega$ load. Both driver outputs and receiver inputs can be forced to $\pm 25V$ without damage, and can survive multiple $\pm 10kV$ ESD strikes.

TYPICAL APPLICATION

2-Drivers/2-Receivers with Shutdown and Driver Disable



Quiescent and Shutdown Supply Current vs Temperature



TEST CONDITION: $V_{CC} = 3.3V$



LTC1385

ABSOLUTE MAXIMUM RATINGS

Supply Voltage (V_{CC})	5V	Short-Circuit Duration	
Input Voltage		V^+	30 sec
Driver	-0.3V to $V_{CC} + 0.3V$	V^-	30 sec
Receiver	-25V to 25V	Driver Output	Indefinite
Digital Input	-0.3V to $V_{CC} + 0.3V$	Receiver Output	Indefinite
Output Voltage		Operating Temperature Range	0°C to 70°C
Driver	-25V to 25V	Storage Temperature Range	-65°C to 150°C
Receiver	-0.3V to $V_{CC} + 0.3V$	Lead Temperature (Soldering, 10 sec)	300°C

PACKAGE/ORDER INFORMATION

<p>TOP VIEW</p> <p>DRIVER DISABLE 1, C1+ 2, V+ 3, C1- 4, C2+ 5, C2- 6, V- 7, TR2 OUT 8, RX2 IN 9, NC 10, ON/OFF 20, VCC 19, GND 18, TR1 OUT 17, RX1 IN 16, RX1 OUT 15, TR1 IN 14, TR2 IN 13, RX2 OUT 12, NC 11</p> <p>G PACKAGE 20-LEAD SSOP</p> <p>$T_{JMAX} = 125^{\circ}C, \theta_{JA} = 135^{\circ}C/W$</p>	<p>ORDER PART NUMBER</p> <p>LTC1385CG</p>	<p>TOP VIEW</p> <p>DRIVER DISABLE 1, C1+ 2, V+ 3, C1- 4, C2+ 5, C2- 6, V- 7, TR2 OUT 8, RX2 IN 9, ON/OFF 18, VCC 17, GND 16, TR1 OUT 15, RX1 IN 14, RX1 OUT 13, TR1 IN 12, TR2 IN 11, RX2 OUT 10</p> <p>N PACKAGE 18-LEAD PLASTIC DIP</p> <p>S PACKAGE 18-LEAD PLASTIC SOL</p> <p>$T_{JMAX} = 125^{\circ}C, \theta_{JA} = 85^{\circ}C/W$</p>	<p>ORDER PART NUMBER</p> <p>LTC1385CN LTC1385CS</p>
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Consult factory for Industrial and Military grade parts.

DC ELECTRICAL CHARACTERISTICS

$V_{CC} = 3.3V, C1 = C2 = C3 = C4 = 0.1\mu F, V_{ON/OFF} = V_{CC},$ Driver Disable = $V_{CC},$ unless otherwise noted.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Any Driver					
Output Voltage Swing	3k to GND	Positive	3.7	4.5	V
		Negative	-3.7	-4.5	V
Logic Input Voltage Level	Input Low Level ($V_{OUT} = \text{High}$)	●	1.4	0.8	V
	Input High Level ($V_{OUT} = \text{Low}$)	●	2.0	1.4	V
Logic Input Current	$V_{IN} = V_{CC}$	●		5	μA
	$V_{IN} = 0V$	●	-20	-40	μA
Output Short-Circuit Current	$V_{OUT} = 0V$		± 10		mA
Output Leakage Current	Shutdown or Driver Disable or $V_{CC} = 0V$ (Note 3,4), $V_{OUT} = \pm 20V$	●	± 10	± 500	μA

DC ELECTRICAL CHARACTERISTICS

$V_{CC} = 3.3V$, $C1 = C2 = C3 = C4 = 0.1\mu F$, $V_{ON/OFF} = V_{CC}$, Driver Disable = V_{CC} , unless otherwise noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Any Receiver						
Input Voltage Thresholds	Input Low Threshold	●	0.8	1.3		V
	Input High Threshold	●		1.7	2.4	V
Hysteresis		●	0.1	0.4	1.0	V
Input Resistance	$-10V \leq V_{IN} \leq 10V$		3	5	7	k Ω
Output Voltage	Output Low, $I_{OUT} = -1.6mA$ ($V_{CC} = 3.3V$)	●		0.2	0.4	V
	Output High, $I_{OUT} = 160\mu A$ ($V_{CC} = 3.3V$)	●	3.0	3.2		V
Output Short-Circuit Current	Sinking Current, $V_{OUT} = V_{CC}$		-5	-20		mA
	Sourcing Current, $V_{OUT} = 0V$		2	7		mA
Output Leakage Current	Shutdown (Note 4), $0V \leq V_{OUT} \leq V_{CC}$	●		1	10	μA
Power Supply Generator						
V^+ Output Voltage	$I_{OUT} = 0mA$			5.7		V
	$I_{OUT} = 5mA$			5.5		V
V^- Output Voltage	$I_{OUT} = 0mA$			-5.3		V
	$I_{OUT} = -5mA$			-5.0		V
Supply Rise Time	Shutdown or Driver Disable to Turn-On			0.2		ms
Power Supply						
V_{CC} Supply Current	No Load (Note 2)	●		0.2	0.5	mA
Supply Leakage Current (V_{CC})	Shutdown (Note 4)	●		0.2	10	μA
	Driver Disable (Note 3)	●		35	50	μA
Digital Input Threshold Low		●		1.4	0.8	V
Digital Input Threshold High		●	2.0	1.4		V

AC CHARACTERISTICS $V_{CC} = 3.3V$, $C1 = C2 = C3 = C4 = 0.1\mu F$, unless otherwise noted.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Slew Rate	$R_L = 3k$, $C_L = 51pF$			8	30	V/ μs
	$R_L = 3k$, $C_L = 1000pF$		3	5		V/ μs
Driver Propagation Delay (TTL to EIA/TIA-562)	t_{HLD} (Figure 1)	●		2	3.5	μs
	t_{LHD} (Figure 1)	●		2	3.5	μs
Receiver Propagation Delay (EIA/TIA-562 to TTL)	t_{HLR} (Figure 2)	●		0.3	0.8	μs
	t_{LHR} (Figure 2)	●		0.2	0.8	μs

The ● denotes specifications which apply over the operating temperature range $0^\circ C \leq T_A \leq 70^\circ C$.

Note 1: Absolute maximum ratings are those values beyond which the life of the device may be impaired.

Note 2: Supply current is measured with driver and receiver outputs unloaded.

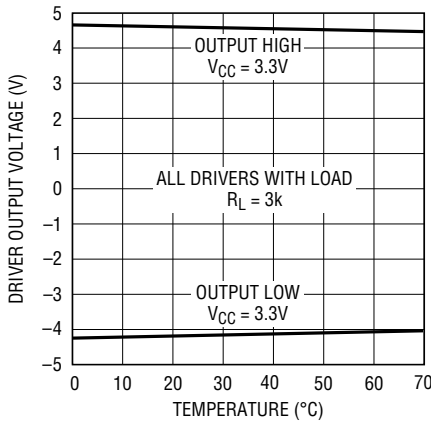
Note 3: Measurements made in the Driver Disable mode are performed with $V_{DRIVER\ DISABLE} = GND$ and $V_{ON/OFF} = V_{CC}$.

Note 4: Measurements made in the Shutdown mode are performed with $V_{ON/OFF} = 0V$.

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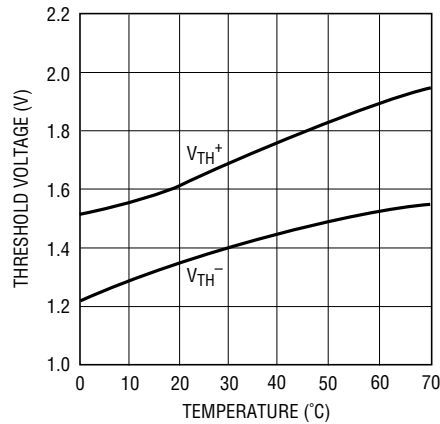
TYPICAL PERFORMANCE CHARACTERISTICS

Driver Output Voltage vs Temperature



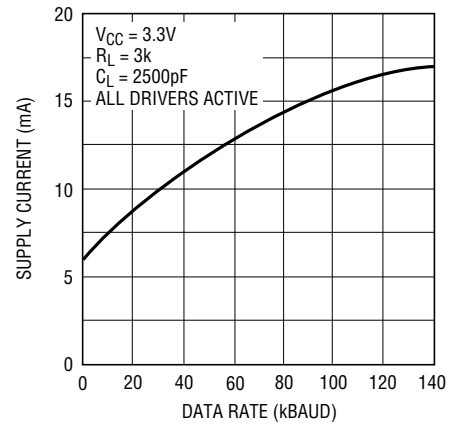
LTC1385 • TPC01

Receiver Input Thresholds vs Temperature



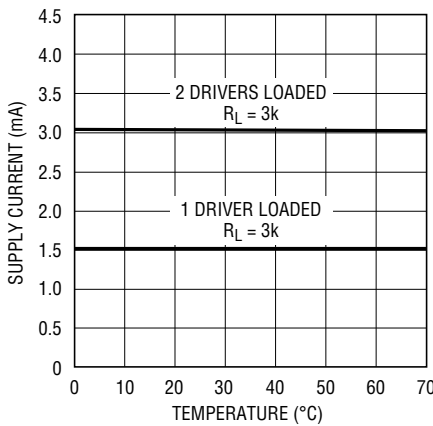
LTC1385 • TPC02

Supply Current vs Data Rate



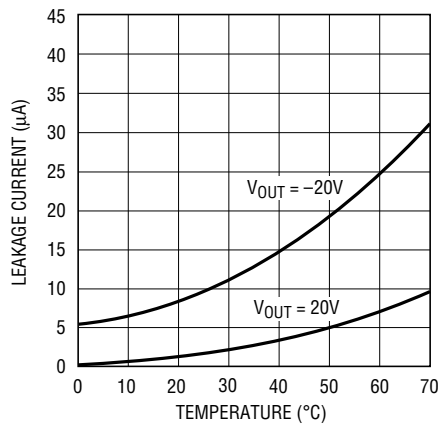
LTC1385 • TPC03

VCC Supply Current vs Temperature



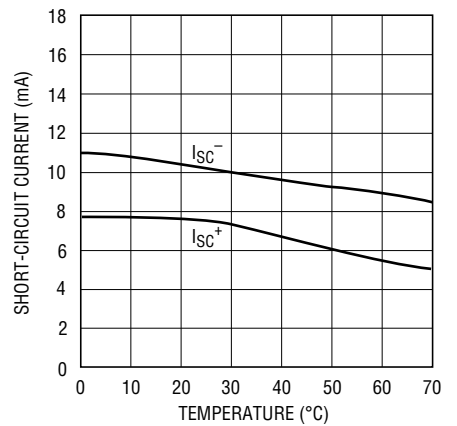
LTC1385 • TPC04

Driver Leakage in Shutdown vs Temperature



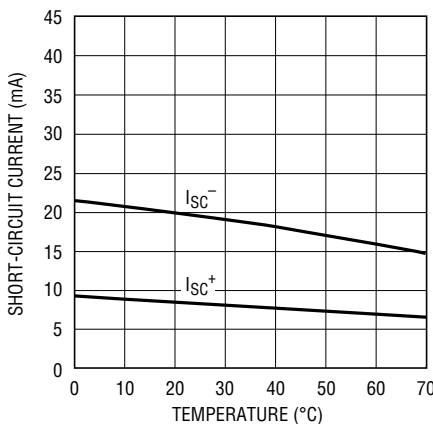
LTC1385 • TPC05

Driver Short-Circuit Current vs Temperature



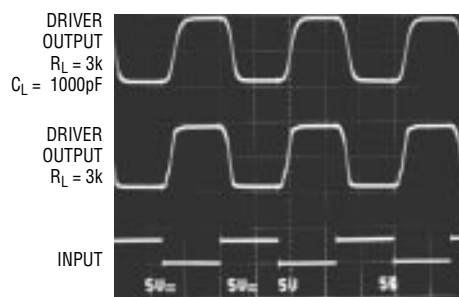
LTC1385 • TPC06

Receiver Short-Circuit Current vs Temperature



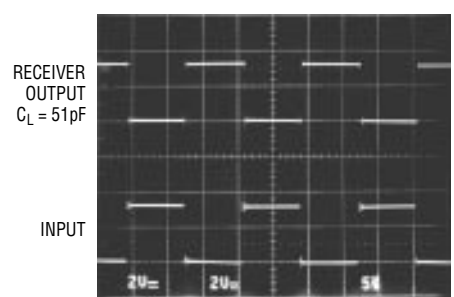
LTC1385 • TPC06

Driver Output Waveforms



LTC1385 • TPC08

Receiver Output Waveform



LTC1385 • TPC09

PIN FUNCTIONS

V_{CC}: 3.3V Input Supply Pin. This pin should be decoupled with a 0.1 μ F ceramic capacitor.

GND: Ground Pin.

ON/OFF: TTL/CMOS Compatible Shutdown Pin. A logic low puts the device in the Shutdown mode independent of the Driver Disable pin. The supply current drops to 0.2 μ A and all driver and receiver outputs are forced into three-state.

DRIVER DISABLE: TTL/CMOS Compatible Input Pin. With the ON/OFF pin held high, a logic low forces the part into the Driver Disable mode with the charge pump turned off and the driver outputs forced into three-state. Both receivers remain active and the supply current drops to 35 μ A. A logic high forces the part into the Normal mode.

V⁺: Positive Supply Output (EIA/TIA-562 Drivers). $V^+ \cong 2V_{CC} - 1V$. This pin requires an external capacitor $C = 0.1\mu F$ for charge storage. The capacitor may be tied to ground or V_{CC} . With multiple devices, the V^+ and V^- pins may share a common capacitor. For a large number of devices, increasing the size of the shared common storage capacitors is recommended to reduce ripple.

V⁻: Negative Supply Output (EIA/TIA-562 Drivers). $V^- \cong -(2V_{CC} - 1.3V)$. This pin requires an external capacitor $C = 0.1\mu F$ for charge storage.

C1⁺, C1⁻, C2⁺, C2⁻: Commutating Capacitor Inputs. These pins require two external capacitors $C = 0.1\mu F$: one from C1⁺ to C1⁻, and another from C2⁺ to C2⁻. To maintain charge pump efficiency, the capacitor's effective series resistance should be less than 2 Ω .

TR IN: EIA/TIA-562 Driver Input Pins. Inputs are TTL/CMOS compatible. The inputs of unused drivers can be left unconnected since 300k input pull-up resistors to V_{CC} are included on chip. To minimize power consumption, the internal driver pull-up resistors are disconnected from V_{CC} in the Shutdown mode.

TR OUT: Driver Outputs at EIA/TIA-562 Voltage Levels. Outputs are in a high impedance state when in the Shutdown or Driver Disable mode or $V_{CC} = 0V$. The driver outputs are protected against ESD to $\pm 10kV$ for human body model discharges.

RX IN: Receiver Inputs. These pins can be forced to $\pm 25V$ without damage. The receiver inputs are protected against ESD to $\pm 10kV$ for human body model discharges. Each receiver provides 0.4V of hysteresis for noise immunity.

RX OUT: Receiver Outputs with TTL/CMOS Voltage Levels. Outputs are in a high impedance state when in the Shutdown mode.

SWITCHING TIME WAVEFORMS

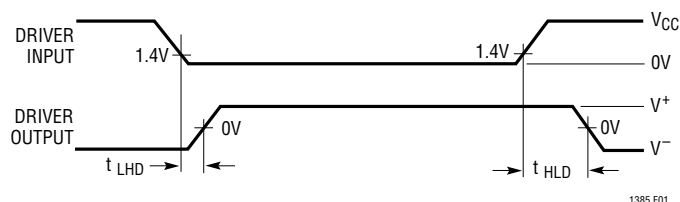


Figure 1. Driver Propagation Delay Timing

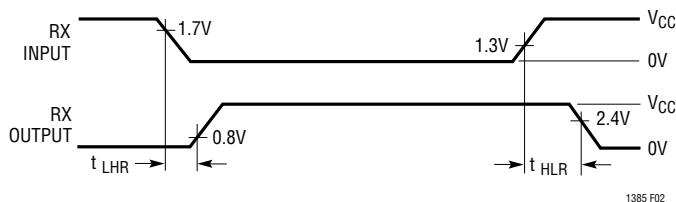
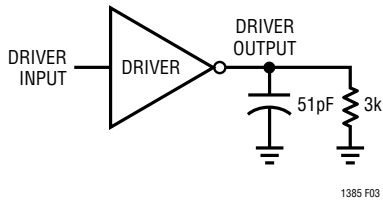


Figure 2. Receiver Propagation Delay Timing

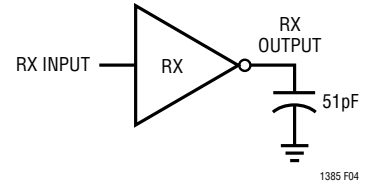
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TEST CIRCUITS

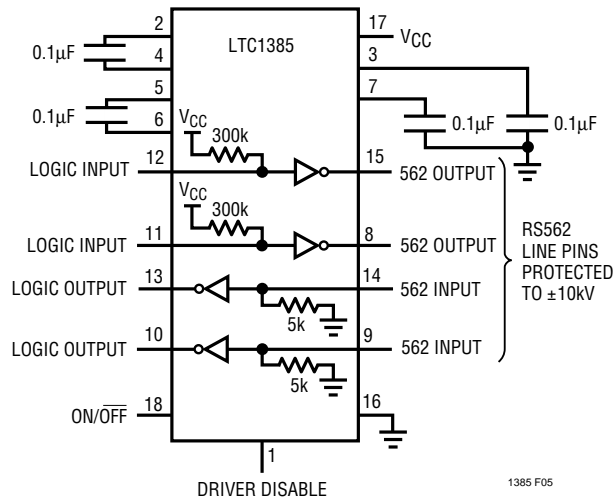
Driver Timing Test Load



Receiver Timing Test Load

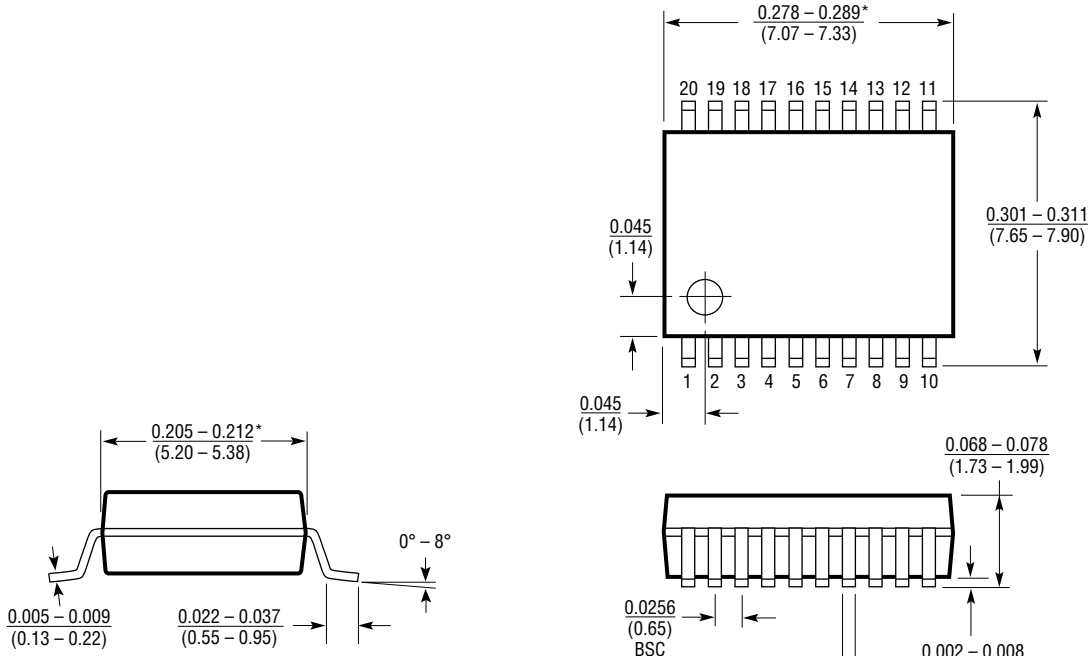


ESD Test Circuit



PACKAGE DESCRIPTION Dimensions in inches (millimeters) unless otherwise noted.

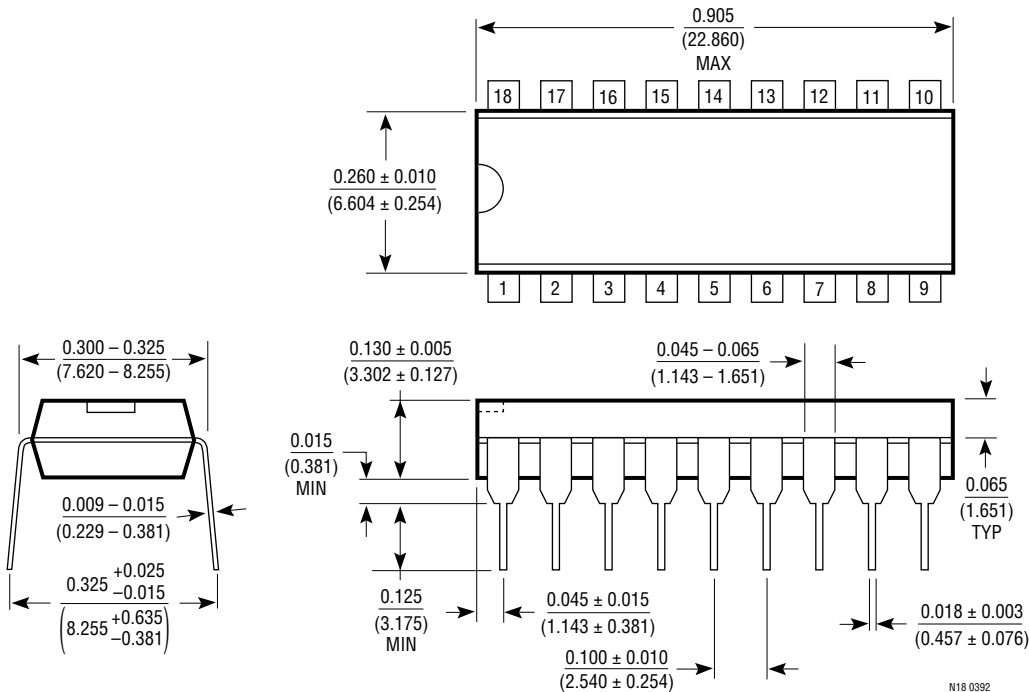
**G Package
20-Lead SSOP**



*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.006 INCH (0.15mm).

20SSOP 0294

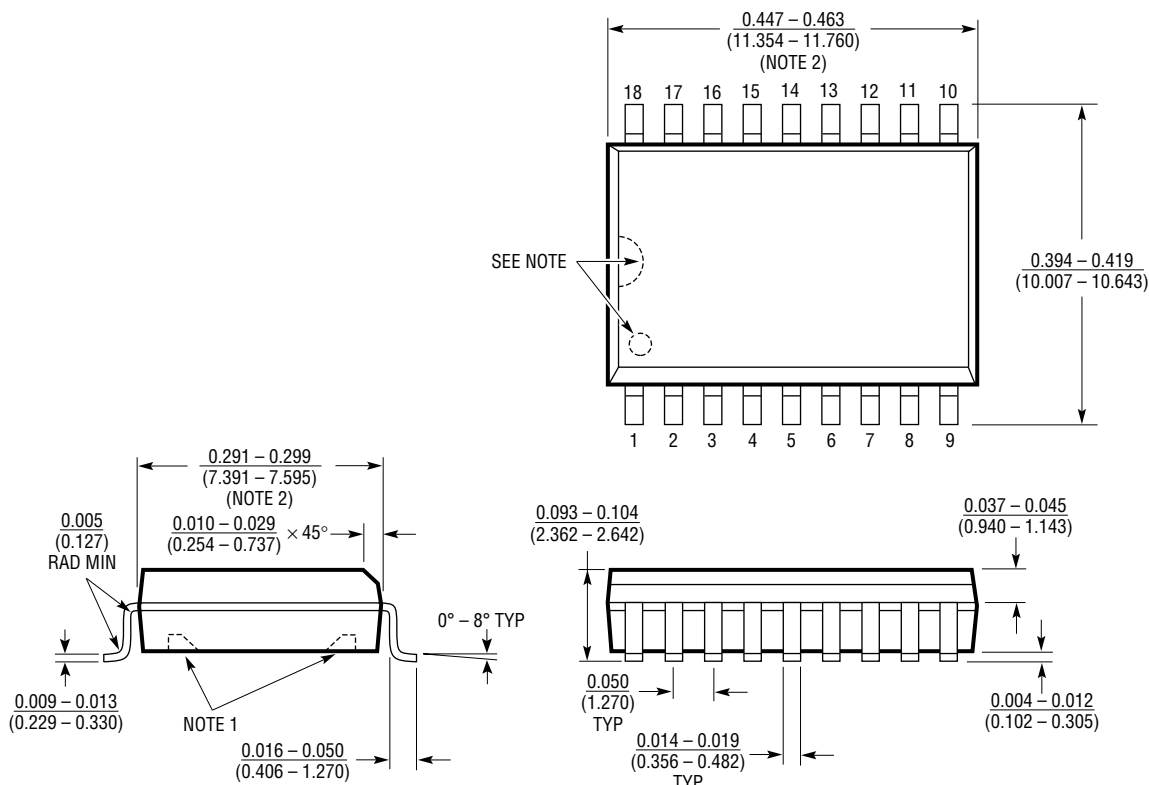
**N Package
18-Lead Plastic DIP**



N18 0392

PACKAGE DESCRIPTION Dimensions in inches (millimeters) unless otherwise noted.

S Package
18-Lead Plastic SOL



- NOTE:
- PIN 1 IDENT, NOTCH ON TOP AND CAVITIES ON THE BOTTOM OF PACKAGES ARE THE MANUFACTURING OPTIONS. THE PART MAY BE SUPPLIED WITH OR WITHOUT ANY OF THE OPTIONS.
 - THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.006 INCH (0.15mm).

SOL18 0392